# MITSUBISHI ELECTRIC CORPORATION ENGLISH VERSION ONLY

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SPECIFICATION	APPROVED BY:	S.Minamihara	v			
	DATE:	Nov. 8. '01	]	: !		

1.TYPE

: ML725B11F-04,05,06,07

2.APPLICATION : Optcal Fiber Communication

3.STRUCTURE : InGaAsP/InP DFB LASER DIODE

4.OUTLINE

: G480570

### **5.ABSOLUTE MAXIMUM RATINGS**

No.	PARAMETER	SYMBOL	CONDITION	RATINGS	UNIT
1	Optical Output Power	Po	CW	6	mW
2	Operating Current	Іор		150	
3	Reverse Voltage (LD)	VRL		2	v
4	Reverse Voltage (PD)	VRD		20	v
5	Forward Current (PD)	IFD		2	mA
6	Case Temperature	Тс		0 to +85	°C
7	Storage Temperature	Tstg		-40 to +100	°C

#### 6. OPTICAL AND ELECTRICAL CHARACTERISTICS

(Tc=25±3°C otherwise specified)

No.	PARAMETER	SYMBOL	CONDITION	LIMITS			UNIT	
140.	FARAMETER	SIMBOL	COMPITION	MIN.	TYP.	MAX.	UNII	
, ,	1 Threshold Current	Ith	CW		6	20	mA	
1		1 11n	CW,Tc=85°C		30	40	mA	
2	Omensking Consent	T	CW,Po=5mW		18	40		
2	Operating Current	Іор	CW,Po=5mW,Tc=85°C		50	75	mA	
3	Operating Voltage	Vop	CW,Po=5mW		1.1	1.8	v	
4	Peak Wavelength	λр	CW,Po=5mW,Tc=25°C	<*2>			nm	
5	Slope efficiency	η	CW,Po=5mW	0.3	0.4		mW/mA	
6	Beam Divergence (Full angle at half	θ	CW,Po=5mW (Parallel)		25	35	deg.	
L	Maximum	$oldsymbol{ heta} \perp$	CW,Po=5mW (Perpendicular)		30	40	deg.	
	Side Mode Suppression	SMSR	CW,Po=5mW,Tc=0 to+85°C	30				
. 7	Ratio		3.0Gbit/s, Ibias=Ith Imod=40mA, Tc=25°C	30			dB	
8	Rise time	tr	622Mbps, Ibias=Ith		60	_	psec	
9	Fall time	tf	10%-90%, short lead-pin		110		psec	
10	Tracking Error	TE	CW,APC Im(25°C)= 5mW TE=10log(Po(Tc)/Po(25°C)) TC=0 to 85°C	-1.0		1.0	dB	
11	Monitor Current (PD)	Im	CW,Po=5mW VRD=1V,RL=10Ω<*1>	0.05	0.2		mA	
12	Dark Current (PD)	Id	VRD=5V			1.0	μΑ	
13	Capacitance (PD)	Ct	VRD=5V, f=1MHz		10	20	pF	
	SPECIFICATION		GNOK-ML725B11F-04-*			PAG	E 1/2	

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<\*1> RL is load resistance of the photo diode.

<\*2> Peak Wave length

TYPE	SYMBOL	TEST CONFISION		J		
			MIN.	TYP.	MAX.	UNIT
ML725B11F-04	λp	CW,Po=5mW Tc=25°C	1270.7	1275.7	1280.7	nm
ML725B11F-05			1295.2	1300.2	1305.2	
ML725B11F-06			1319.7	1324.7	1329.7	
ML725B11F-07			1344.2	1349.2	1354.2	

#### 7. ACCOMPANYING INSPECTION DATA

Ith, Iop, Vop,  $\eta$ ,  $\lambda$  p, Im(@Po=5mW, Tc=25°C)

# 8. Safety precautions relating to handling of optical semiconductor device General:

Although the manufacturer is always striving to improve the reliability of its products, problems and errors may occur with semiconductor products. Hence, it is required so that the user's products are designed with full regard to safety by incorporating the redundancy, fire prevention, error prevention so that any problems or error with a semiconductor product does not cause any accidents resulting in injury or death, fire, or environmental damage. The following requirements must be strictly observed.

#### Warning!

#### 1. Avoid laser light entering the eyes

In normal operation the semiconductor laser device, an optical device, emits laser light. Laser light entering the eye causes extreme danger. Never look directly at the laser light, and never look it directly through an optical system such as a lens. Use an ITV camera or IR viewer to observe the laser light.

#### 2. Handling of the product

This product uses GaAs (gallium arsenate). In normal conditions this product is not toxic. However, if it is powdered or vaporized, its powder or vapor is dangerous to humans. Never attempt to crush, grind, bake or chemically treat this product. Do not put this product into your mouth or swallow it.

#### 3. Discarding the product

This product uses GaAs (gallium arsenate). It should be discarded as a specially controlled industrial waste, it should be separated from general industrial and household wastes, according to the "Law of Wastes and Cleaning".

#### Caution!

#### 1. High temperature

During operation the product may become hot. Therefore do not touch it directly during operation. The product will remain hot even after the power is turned off, so wait until it cools before you touch it. Otherwise burns may be caused. Never place any inflammable substance, which may cause a fire near the product.

	SPECIFICATION	GNOK-ML725B11F-04-*		PAGE 2/2
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